INSTRUCTIONS:

- 1. Read the Access to Intellectual Property & Non-Disclosure Agreement.
- 2. Fill in required fields (name, city, and signatory and witness information). Print all information legibly.
- 3. Sign the agreement. Original ("wet") signatures or secure electronic are required.
- 4. Email signed form to Sarah Neville (<u>Sarah.Neville@cmc.ca</u>). Note: A high resolution photograph of the signed agreement is acceptable.

2023 PASSIVE SILICON PHOTONICS FABRICATION COURSE (ON-LINE) ACCESS TO INTELLECTUAL PROPERTY & NON-DISCLOSURE AGREEMENT

I	of the City/Town of
(Course Part	cipant Full Name, Print)
	acknowledge and agree that:
	(City/Town, Print)
to a laboratory, facility, project wafer chips comproprietary information ("Co of CMC, Confidential Intwith course participants, an	CANADIAN MICROELECTRONICS CORPORATION CROSYSTEMS (herein called "CMC") I may have access electronic content, documentation and/or fabricated multiaining non-public intellectual property and confidential and
undertake that I will not at thordered so to do by law or co	ving me access to said Confidential Information, I declare and s time or any future time disclose any Confidential Information unless ourt process. If I am required to disclose Confidential Information by law vide CMC with prompt written notice to enable CMC to seek a priate remedy.
I further declare and undertake:	
(a) not to record the course, an	d
Information obtained through would be stored (including earlier of: (i) a written reque (d) to abide by all applicable ex	to delete any and all paper and electronic copies of Confidential ph my association with CMC from any and all systems where they any hard drives, memory sticks or backup storage devices) upon the st by CMC, or (ii) the end of my association with CMC, and port controls, laws and regulations of the United States, Canada and other art, import and/or re-export of information, technology and related items.
Signature:	
Name:	
Title:	
Institution / Company Name:	
Address:	

Date: